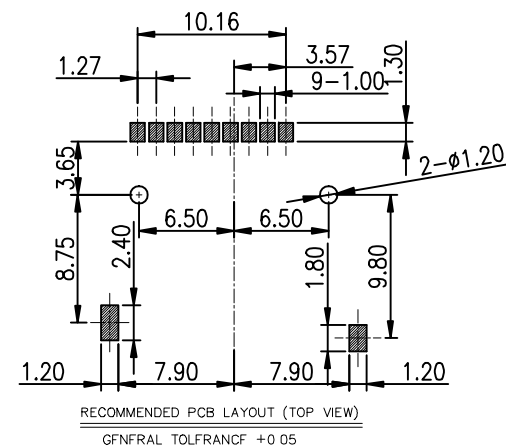
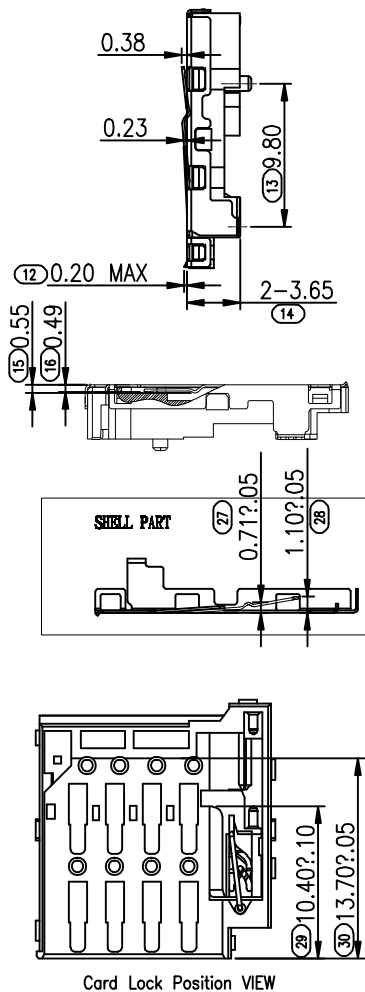
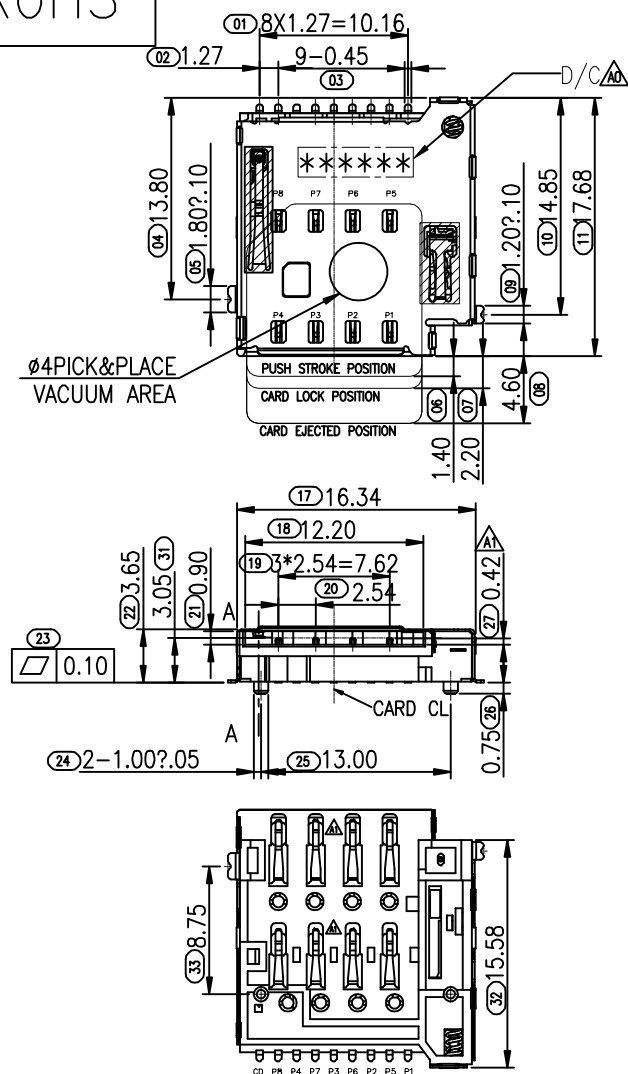


RoHS



6	Housing	1PC	High Temperature Thermoplastic	UL94V-0; Color Black
5	LINK	1PC	Stainless Steel	plating Ni: 30u"min
4	SPRING	1PC	SWP-B	plating Ni: 30u"min
3	Slider	1PC	High Temperature Thermoplastic	UL94V-0; Color Black
2	Shell	1PC	Stainless Steel	Slider plating Au: 1u", Ni: 30u"min
1	Termiral	1PC	Copper Alloy.	Contact Au: G.F" plating ; slider Au: G.F", Ni: 50u"min
NO	Description	Dosage	Material	Color/plating

REV.	EC#	DESCRIPTION	DATE	DRAWING	CHECKED	APPROVED
A0	ECN1805007	根据客户要求修改包装	16/05'18	SUPER	SKY	TEDDY
A1	ECN1905021	根据客户要求修正产品结构	05/23'19	TEDDY		LHY

NOTES:

1. MATERIAL:

1.1 Housing: High Temperature Thermoplastic
UL94V-0; Color Black.

1.2 Terminal: Copper Alloy.

1.3 Shell: Stainless Steel.

2. SPECIALITY:

2.1 Rated current: 1.0A

2.2 Rated voltage: 50V

2.3 Contact Resistance: 50mΩ MAX

2.4 Insulation Resistance: 1000MΩ MIN 500V DC

2.5 Dielectric withstanding voltage: 500V AC.

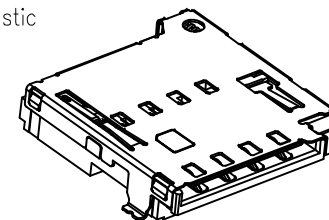
2.6 Solder ability: 255±5℃, 5±0.5s.

2.7 Durability: 5000 Cycles Min.

2.8 Operating condition: Temperature -40℃~+85℃;

Humidity 80% R.H MAX

3. PLEASE CONTACT JITS SALES REPRESENTATIVE TO VERIFY PRODUCT DETAILS
& AVAILABILITY



东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.

PART NUMBER:
XB-102322102

TITLE:
MICRO SIM IF-3.65 8PIN PUSH PUSH卡座

APPD:

DWG NO.:
C-102322102-00

CHKD:

DR:



SCALE	SHEET	REV.
1:1	1/2	A1

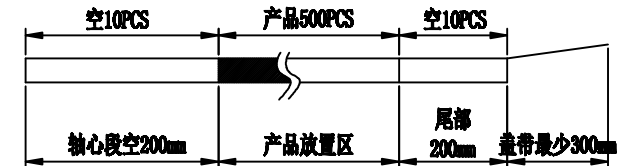
RoHS

组装包装方向

客户出料方向

NOTES

1. 每卷包装数量:500PCS/每卷
2. 卷带包装方式:



3. 每箱包装数量:3000PCS/箱

盖带剥离角度:165°~180°
剥离力:20~130g

载带

DETAIL 1(Scale:8:1)

封箱胶带“工”字形封好

MILLIMETERS	INCH	UNITS	东莞市溪榜电子有限公司			
		MM	DONG GUAN XI BANG ELECTRONICS CO., LTD.			
X. ± 2'			PART NUMBER:		TITLE:	
.X ± 0.30			SEE NOTES		XB-102322102	
.XX ± 0.20			FINISH		MICRO SIM IF-3.65 8PIN PUSH PUSH卡座	
.XXX ± 0.10			SEE NOTES		DWG NO.:	
			QTY		C-102322102-00	
			SEE NOTES		SCALE SHEET REV.	
			CHKD:		1:1 2/2 A1	
			DR:			